

MODEL NO :	TM104TDGF	<u>10</u>
MODEL VERSION:	00	
SPEC VERSION :	Ver 2.3	
ISSUED DATE:	2021-12-02	$\langle \rangle$
	<pre>> Specification ict Specificatio</pre>	on

Customer :		
	Approved by	Notes
	S	

TIANMA Confirmed :

Prepared by	Checked by	Approved by
Panpan Cao	Longping Deng	Xiaoxing Ding

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



Table of Contents

Tab	le of Contents	2
Rec	cord of Revision	3
1	General Specifications	4
2	Input/Output Terminals	
3	Absolute Maximum Ratings	
4	Electrical Characteristics	
5	Timing Chart	10
6	Optical Characteristics	13
7	Environmental / Reliability Test	16
8	Mechanical Drawing	17
9	Packing Drawing	18
10	Precautions for Use of LCD Modules	19



Record of Revision

Rev	Issued Date	Description	Editor
1.0	2019-01-14	Preliminary Product Specification Release	Panpan Cao
1.1	2019-07-17	Update mechanical drawing	Panpan Cao
1.2	2019-8-23	4.2 Driving Backlight Update LED life time 6 Optical Characteristics Update Luminance	Panpan Cao
1.3	2020-2-21	6 Optical characteristic Update Response time	Panpan Cao
1.4	2020-6-16	6 Optical characteristic Update Chromaticity Update mechanical drawing	Panpan Cao
2.0	2020-7-30	Final Product Specification Release	Panpan Cao
2.1	2020-9-3	Change Driving Backlight of page 11, High Level Input Voltage changed to 3.3V	Longping.Deng
2.2	2021-9-29	Update 4.1 Driving TFT LCD Panel& 4.2 Driving Backlight in page 8. Current of digital supply voltage: MAX 568mA Power consumption: MAX 1875mW Current of Backlight Power: MAX 0.46A Backlight Power Consumption: MAX5.52W	Panpan Cao
2.3	2021-12-02	Update LCM connector type in P4 ,P5 and P17	Panpan Cao

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



1 General Specifications

	Feature	Spec	
	Size	10.4 inch	
	Resolution	1024(RGB) x 768	
	Technology Type	a-Si	
Display Space	Pixel Configuration	R.G.B. Vertical Stripe	
Display Spec.	Pixel pitch(mm)	0.2055x0.2055	
	Display Mode	TM with Normally Black	
	Surface Treatment	Anti-Glare	
	Viewing Direction	All direction	
	LCM (W x H x D) (mm)	230.00x175.80x5.70	
	Active Area(mm)	210.432×157.824	
Mechanical	With /Without TSP	Without TSP	
Characteristics	LCM connector	DF19K-20P-1H	
	Matching Connector	DF19-20S-1C	
	LED Numbers	32 pcs	
	Weight (g)	430	
Fischrice!	Interface	1port LVDS, 6/8bit selectable	
Electrical Characteristics	Color Depth	16.7M/262K	
onaracteristics	Driver IC	RM51150 *1+ RM76870*2	

Note 1: Requirements on Environmental Protection: Q/S0002

Note 2: LCM weight tolerance: ± 5%



Input/Output Terminals 2

2.1 TFT LCD panel

CN1 Connector : DF19K-20P-1H Matching Connector: DF19-20S-1C

Pin No	Name	Symbol	Pin Function Description	
1	VDD	Р	Power Voltage for digital circuit	
2	VDD	Р	Power Voltage for digital circuit	
3	GND	Р	Ground	
4	DPS	I	L:Forward Scan H:Reverse Scan	
5	RxCLKI N-	I	- LVDS differential clock input	
6	RxCLKI N+	I	+ LVDS differential clock input	
7	GND	Р	Ground	
8	RxIN0-	I	- LVDS differential data input	
9	RxIN0+	I	+ LVDS differential data input	
10	GND	Р	Ground	
11	RxIN1-	I	- LVDS differential data input	
12	RxIN1+	I	+ LVDS differential data input	
13	GND	Р	Ground	
14	RxIN2-	I	- LVDS differential data input	
15	RxIN2+	I	+ LVDS differential data input	
16	GND	Р	Ground	
17	RxIN3-	I	- LVDS differential data input	
18	RxIN3+	I	+ LVDS differential data input	
19	AG Mode	I	Normal operation/BIST pattern select H:BIST; L: Normal	
20	HSD	I	6bit/8bit mode select : H:6bit; L:8bit	

P: Power/GND; I: input pin

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



Note1: LVDS 6-bit data mapping when SEL68/HSD=H as follows:

6-bit LVDS input (HSD = "H")



LVDS 8-bit data mapping when SEL68/HSD =L as follows:

8-bit LVDS input (HSD = "L")



Figure 2.1.2 Input signal data mapping

Note2: DPS: Scan direction setting

DPS	Horizontal Scan direction	Vertical Scan direction
High	Right to left	Down to up
Low	Left to right	Up to down

2.2 CN2(Backlight Connector)

CN2 Connector: 3808K-F05N-03R (ENTERY)

Matching Connector: H208K-D05N-22B +M002N-F07N-22R

Pin No	Name	Symbol	Pin Function Description
1	VCC	Р	Power Voltage for LED driver IC-12V
2	GND	Р	Ground
3	Dimming	I	Dimming Control Input
4	EN	I	Enable (Active High) for LED driver IC
5	NC	-	No connection

P: Power/GND; I: input pin



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V, Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Power Voltage for LCD	VDD	-0.5	5.0	V	
Power for LED driving circuit	VCC	-0.3	13.0	V	Note1
Input voltage for LCD	VIN	-0.5	5.0	V	
Input voltage for backlight	Vt	-0.3	13.0	V	Note2; Note3
Operating Temperature	TOPR	-20	+70	°C	Note4
Storage Temperature	TSTG	-30	+80	Ĵ	NOIE4
			≪95	%	Ta≪40℃
Deletive House idites			≤85	%	40° C <i><</i> Ta≤50°C
Relative Humidity Note2	RH		≤55	%	50° C <i><</i> Ta ≤60°C
NOLEZ			≤36	%	60° C <i><</i> Ta≤70°C
			≦24	%	70° C <i><</i> Ta≤80°C
Absolute Humidity	AH		≦70	g/m³	Ta>70° ℃

Table 3 Absolute Maximum Ratings

Note1: V_{IN} represents RxIN0±,RxIN1±,RxIN2±,RxIN3±,RxCLKIN±,DPS,AGMode,HSD.

Note2: Vt represents EN and Dimming.

Note3: Should keep the maximum value of EN and Dimming are equal.

Note4: Ta means the ambient temperature.

It is necessary to limit the relative humidity to the specified temperature range. Condensation on the module is not allowed.

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, **Ta=25**[°]C

lte	em	Symbol	MIN	TYP	MAX	Unit	Remark
Digital s Voltage	upply	VDD	3.1	3.3	3.5	V	
Input Signal	Low Level	V _{IL}	0	-	0.3xVDD	V	R0~R7,G0~G7,0~B7,DE, DCLK,HSYNC,VSYNC,MODE,
Signal Voltage	High Level	V _{IH}	0.7xVDD	-	VDD	\sim	RESET, DITH
Current supply v	of digital oltage	I _{VDD}	-	430	568	mA	VCC=3.3V,all white pattern
Power consum	ption	Р	-	1419	1875	mW	This value may vary with different patterns.

Figure 4.1.1 LVDS DC timing diagram

Note1: For different LCM, the value may have a bit of difference.

Note2: There is tolerance in optimum VCOM voltage during production ,Minimum and maximum VCOM voltages indicate the range of optimum VCOM voltage shift due to production tolerance. Typ .VCOM is only a reference value, it must be optimized ,according to each LCM .Be sure to use VR.

4.2 Driving Backlight

Ta=25℃

ltem	Symbol	Min	Тур	Max	Unit	Remark		
Power for LED driving circuit	VCC	11.0	12.0	13.0	V			
Current of Backlight Power	Ivcc	-	0.33	0.46	Α			
Rush Current	Irush_VCC		-	1.5	Α			
Backlight Power Consumption	W _{BL}	-	3.96	5.52	W			
Dimming Frequency	F _{PWM}	0.1K	-	20K	Hz			
Dimming duty cycle	-	0	-	100%	-			
High Level Input Voltage	V _{IH}	3.0	3.3	3.5	V	For Dimming, EN pin		
Low Level Input Voltage	V _{IL}	-	-	0.5	V	For Dimming, EN pin		
LED Life time	-	40000	50000		Hr			

Note1: Optical performance should be evaluated at Ta=25°C only.

If LED is driven by high current, high ambient temperature & humidity condition, the life time of LED will be reduced.

Operating life means brightness goes down to 50% initial brightness.

Typical operating life time is estimated data.



其中对于 BL LED CIRCUIT, 120mA 恒流驱动 (30mA for each LED), 25.6V (typ), 其中 8S4P 共计 32 颗 LED



4.3 Block Diagram





5 Timing Chart

5.1 Timing Parameter

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Differential Input high Threshold voltage	RXVTH	-	-	+0.2	V	Rxvcm=1.2V	
Differential Input Low Threshold voltage	RXVTL	-0.2	×	9 8 9	V		
Input voltage range (signaled-end)	RXVIN	0		VDD-1.2	V		
Differential Input common Mode voltage	RXVCM	Vip /2	2	VDD-1.2- Vib /2	V	1. - .1	
Differential Input voltage	Vid	0.2	-	0.6	V		
Differential Input leakage Current	RVxiiz	-10	10	+10	uA	-	
LVDS Digital Operating Current	Iddlvds	1. 	15	30	mA	Fclk=65MHz, VDD=3.3V	
LVDS Digital Stand-by Current	Istlvds	4	10	50	uA	Clock & all functions are stopped	





ltem	Symbol	Min	Тур	Max	Unit	Remark
VDD on to VDD stable	Tp1	0.5	-	10	ms	-
VDD stable to signal on	Tp2	0	-	50	ms	_
Signal on to VLED_EN on	Тр3	200	-	-	ms	-
PWM on to VLED_EN on	Tp4	0	-	200	ms	-
VLED to PWM on	Tp5	10	-	-	ms	X
VLED on to VELD stable	Tp6	0.5	-	10	ms	
VDD off time	Tp7	0	-	10	ms	-
VDD off to next VDD on	Tp8	500	-	-	ms	-
Signal off before VDD off	Tp9	0	-	50	ms	_
VLED_EN off before signal off	Tp10	200	-	-	ms	_
VLED_EN off before PWM off	Tp11	0		200	ms	_
PWM off before VLED off	Tp12	10		-	ms	_

5.2 Power On/Off Sequence

Table 5.4 Power on/off sequence





	Parameter	Symbol	Min.	Тур.	Max.	Unit	Remarks
Dclk frequency		1/Tclk	52	65	71	MHz	-
	Horizontal total	Th	1114	1344	1400	DCLK	-
Horizontal section	Horizontal blanking	Thb	90	320	376	DCLK	-
0001011	Valid Data Width	Thd		1024		DCLK	-
	Frame rate	-	-	60		Hz	-
Vertical	Vertical total	Τv	778	806	845	Th	-
section	Vertical blanking	Tvb	10	38	77	Th	-
	Valid Data Width	Tvd		768		Th	-

5.3 Recommended Input Timing of LVDS transmitter

Input Timing Control Conditions



6 Optical Characteristics

Ta=25℃

ltem		Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		75	85			
View Angles		θΒ	CR≧10	75	85		Degree	
View Angles		θL		75	85			Note2,3
		θR		75	85			
Contrast Ratio)	CR	θ=0°	1000	1200			Note 3
Boononco Tim	D		25 ℃	-	35	45	ms N	Note 4
Response Time		T_{OFF}	25 C					NOLE 4
	White	x	Backlight is on	0.258	0.308	0.358		Note 1,5
		У		0.282	0.332	0.382		
	Red	х		0.548	0.598	0.648		Note 1,5
Chromaticity	Reu	у		0.272	0.322	0.372		
Chromaticity	Green	x		0.283	0.333	0.383		Note 1,5
	Green	У		0.547	0.597	0.647		
	Blue	х		0.104	0.154	0.204		Noto 1 5
		У		0.062	0.112	0.162		Note 1,5
Uniformity		U		75	85		%	Note 6
NTSC				45	50		%	Note 5
Luminance		4		400	450		cd/m ²	Note 7

Test Conditions:

- 1. I_F = 30 mA (for each LED), and the ambient temperature is 25 °C.
- 2. The test systems refer to Note 1 and Note 2.

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD.



"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined.



Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 10% to 90%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 90% to 10%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/ Lmax

L-----Active area length W----- Active area width



Lmax: The measured Maximum luminance of all measurement position.

Lmin: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



7 Environmental / Reliability Test

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ta=+70℃, 240hrs	IEC60068-2-1:2007 GB2423.2-2008
2	Low Temperature Operation	Ta=-20°C, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage+	Ta=+80℃, 240hrs	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
5	Operation at High Temperature and Humidity	Ta = +60℃, 90% RH max,240 hours	IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (non-operation)	-30℃ 30 min~+80℃ 30 min, Change time:5min, 100 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,G B2423.22-2002
7	ESD	C=150pF, R=330 Ω, 5point/panel Air: ±15kv, 5times; Contact: ±8kv, 5times; (Environment: 15℃~35℃, 30%~60%, 86Kpa~106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006

Note1: Ta is the ambient temperature of sample.

Note2: Before cosmetic and function test, the product must have enough recovery time, at least 24 hours at room temperature.

Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



8 Mechanical Drawing



The information contained herein is the exclusive property of TIANMA MICRO-ELECTRONICS Corporation and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of TIANMA MICRO-ELECTRONICS Corporation.



9 Packing Drawing

1.包装材料规格表(Packaging Material)

Per Carton

No	Item	Model (Materiel)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Material Number	
1	LCM Module	TM104TDGP10-00	230.00×175.80×5.70	0.430	18	TM104TDGP10-00	
2	Tray	PET (transmittance)	485×330×19	0.258	12	1150346240	
3	Dust-Proof Bag	PE	700×545×0.05	0.05	1	1680009800	
4	вох	Corrugated Paper	520×345×74	0.369	3	1680319080	
6	Carton	Corrugated Paper	544×365×250	0.76	1	1680342370	
	Total Weight	12.753±5%					





10 Precautions for Use of LCD Modules

10.1 Handling Precautions

10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

Isopropyl alcohol

Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water

Ketone

Aromatic solvents

10.1.6 Do not attempt to disassemble the LCD Module.

10.1.7 If the logic circuit power is off, do not apply the input signals.

10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

10.1.8.1 Be sure to ground the body when handling the LCD Modules.

10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.

10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C $\sim 40^{\circ}$ C Relatively humidity: $\leq 80\%$

10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

10.3 Transportation Precautions

10.3.1 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.